

88D D ■ 8235605 0014918 7 ■ SIEG
88D 14918 D T-39-13

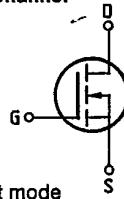
BUZ 214

SIEMENS AKTIENGESELLSCHAFT

Main ratings

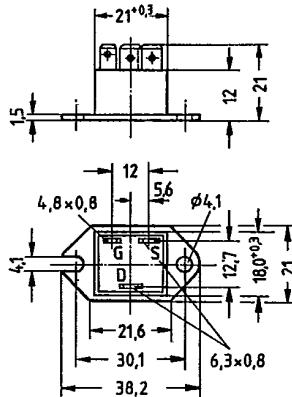
Drain-source voltage V_{DS} = 500 V
Continuous drain current I_D = 7 A
Drain-source on-resistance $R_{DS(on)}$ = 0,8 Ω

N-Channel



Description FREDET with fast-recovery reverse diode, N-channel, enhancement mode
Case Plastic package TO 238 AA with insulated metal base plate in accordance with JEDEC, compatible with TO 3; AMP plug-in connections.
Approx. weight 21 g

Type	Ordering code
BUZ 214	C67078-A1701-A2



Dimensions in mm

Maximum ratings

Description	Symbols	Ratings	Units	Conditions
Drain-source voltage	V_{DS}	500	V	
Drain-gate voltage	V_{GDR}	500	V	$R_{GS} = 20 \text{ k}\Omega$
Continuous drain current	I_D	7	A	$T_C = 40^\circ\text{C}$
Pulsed drain current	$I_{D(\text{puls})}$	28	A	$T_C = 25^\circ\text{C}$
Gate-source voltage	V_{GS}	± 20	V	
Max. power dissipation	P_0	83,3	W	$T_C = 25^\circ\text{C}$
Operating and storage temperature range	T_J			
Isolation test voltage	T_{stg}	-40 ... +150	$^\circ\text{C}$	
DIN humidity category	V_{is}	3500	Vdc ¹⁾	$t = 1 \text{ min}$
IEC climatic category		F	-	DIN 40040
		40/150/56		DIN IEC 68-1

Thermal resistance

Chip - case | R_{thJC} | $\leq 1,5$ | K/W |

¹⁾) Isolation test voltage between drain and base plate referred to standard climate 23/50 in accordance with DIN 50014.

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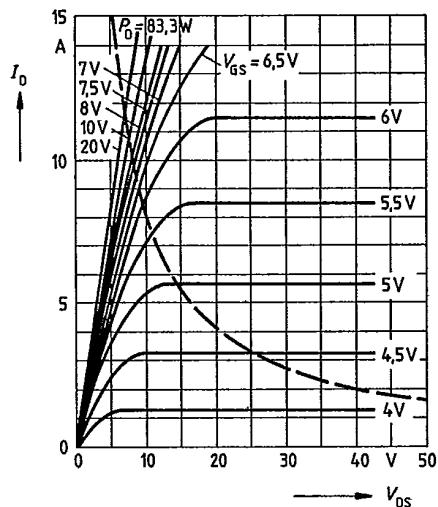
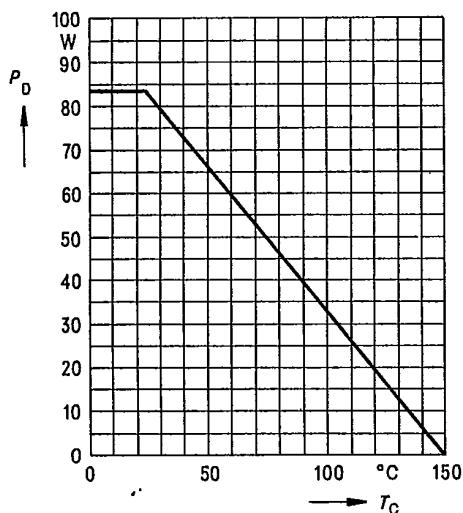
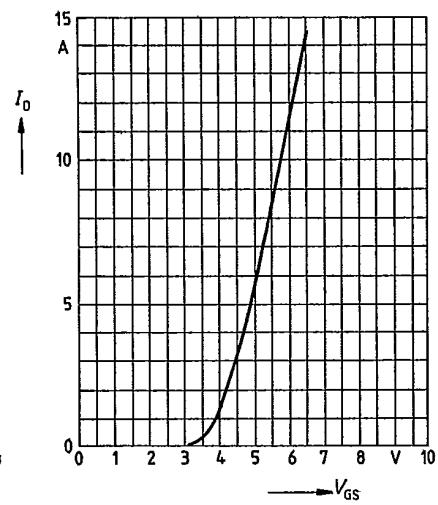
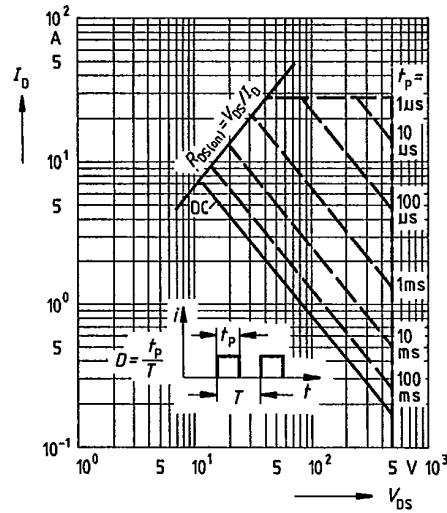
SIEMENS AKTIENGESELLSCHAFT**Electrical characteristics**(at $T_j = 25^\circ\text{C}$ unless otherwise specified)

Description	Symbol	Characteristics			Unit	Conditions
		min.	typ.	max.		
Static ratings						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	500	—	—	V	$V_{GS} = 0\text{V}$ $I_D = 0,25\text{mA}$
Gate threshold voltage	$V_{GS(\text{th})}$	2,1	3,0	4,0		$V_{DS} = V_{GS}$ $I_D = 1\text{mA}$
Zero gate voltage drain current	I_{DSS}	— —	20 100	250 1000	μA	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$ $V_{DS} = 500\text{V}$ $V_{GS} = 0\text{V}$
Gate-source leakage current	I_{GSS}	—	10	100		$V_{GS} = 20\text{V}$ $V_{DS} = 0\text{V}$
Drain-source on-resistance	$R_{DS(\text{on})}$	—	0,7	0,8	Ω	$V_{GS} = 10\text{V}$ $I_D = 5,5\text{A}$
Dynamic ratings						
Forward transconductance	g_{fs}	2,7	5,3	—	S	$V_{DS} = 25\text{V}$ $I_D = 5,5\text{A}$
Input capacitance	C_{iss}	—	3,8	4,9		$V_{GS} = 0\text{V}$
Output capacitance	C_{oss}	—	250	400		$V_{DS} = 25\text{V}$
Reverse transfer capacitance	C_{rss}	—	100	170		$f = 1\text{MHz}$
Turn-on time t_{on} ($t_{on} = t_{d(on)} + t_f$)	$t_{d(on)}$ t_f	— —	50 80	75 120	ns	$V_{CC} = 30\text{V}$ $I_D = 2,8\text{A}$ $V_{GS} = 10\text{V}$ $R_{GS} = 50\Omega$
Turn-off time t_{off} ($t_{off} = t_{d(off)} + t_f$)	$t_{d(off)}$ t_f	— —	330 110	430 140		
Fast-recovery reverse diode						
Continuous reverse drain current	I_{DR}	—	—	7	A	$T_C = 25^\circ\text{C}$
Pulsed reverse drain current	I_{DRM}	—	—	28		
Diode forward on-voltage	V_{SD}	—	1,3	1,6	V	$I_F = 2 \times I_{DR}$ $V_{GS} = 0\text{V}, T_j = 25^\circ\text{C}$
Reverse recovery time	t_{rr}	— —	180 220	250 300		$T_j = 25^\circ\text{C}$ $= 150^\circ\text{C}$
Reserve recovery charge	Q_{rr}	— —	0,65 2,6	1,2 5,0	μC	$T_j = 25^\circ\text{C}$ $= 150^\circ\text{C}$
Repetitive peak reverse current	I_{RRM}	— —	— 15	—		$T_j = 25^\circ\text{C}$ $= 150^\circ\text{C}$

88D D ■ 8235605 0014920 5 ■ SIEG

88D 14920 D T-39-13

BUZ 214

SIEMENS AKTIENGESELLSCHAFTPower dissipation $P_D = f(T_C)$ Typical output characteristics $I_D = f(V_{DS})$
parameter: 80 μ s pulse test,
 $T_j = 25^\circ\text{C}$ Safe operating area $I_D = f(V_{DS})$
parameter: $D = 0.01, T_C = 25^\circ\text{C}$ Typical transfer characteristic $I_D = f(V_{GS})$
parameter: 80 μ s pulse test,
 $V_{DS} = 25\text{V}, T_j = 25^\circ\text{C}$ 

630

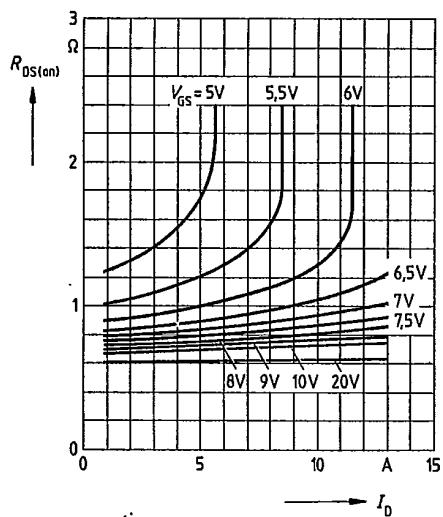
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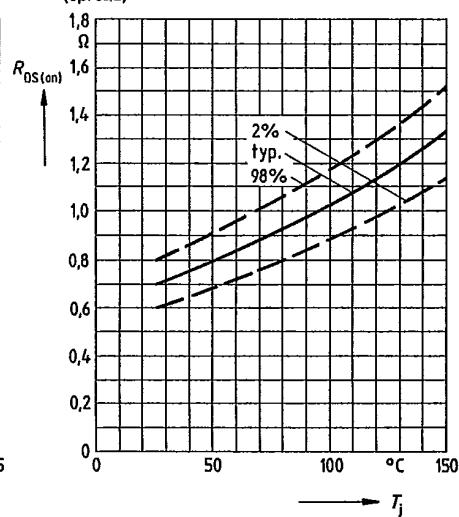
Typical drain-source on-state resistance

$R_{DS(on)} = f(I_D)$
parameter: $V_{GS} = 10V$; $T_j = 25^\circ C$

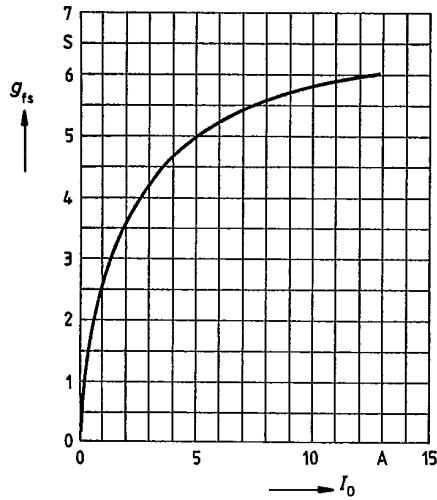


Drain-source on-state resistance

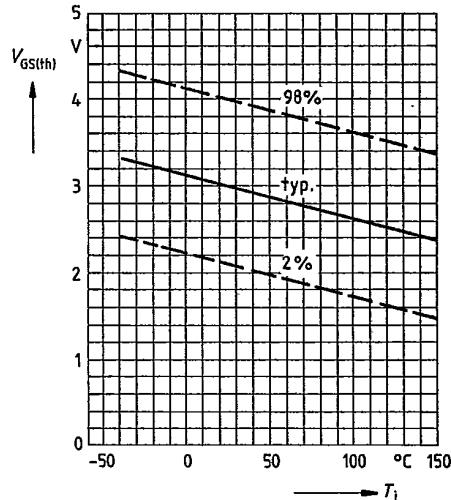
$R_{DS(on)} = f(T_j)$
parameter: $I_D = 5.5A$, $V_{GS} = 10V$
(spread)

Typical transconductance $g_{fs} = f(I_D)$

parameter: 80 μs pulse test,
 $V_{DS} = 25V$, $T_j = 25^\circ C$

Gate threshold voltage $V_{GS(th)} = f(T_j)$

parameter: $V_{DS} = V_{GS}$, $I_D = 1mA$
(spread)



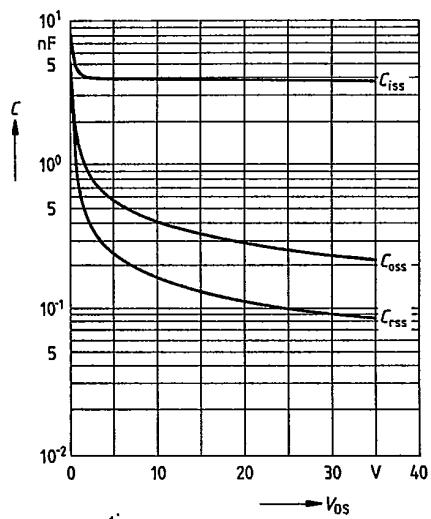
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88D 14922 D T-39-13

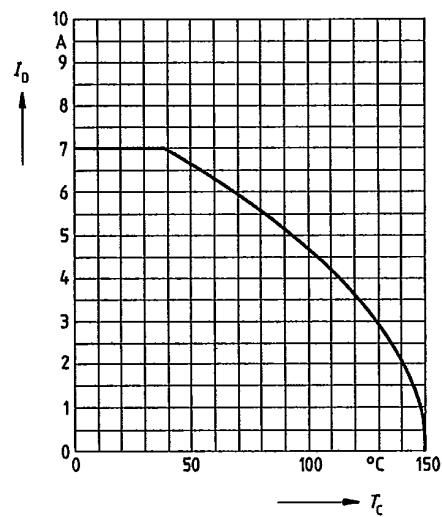
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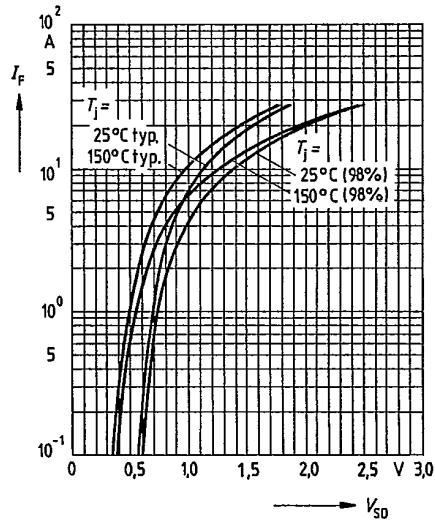
Typical capacitances $C = f(V_{DS})$
parameter: $V_{GS} = 0$, $f = 1\text{MHz}$



Continuous drain current $I_D = f(T_C)$
parameter: $V_{GS} \geq 10\text{V}$



Forward characteristic of reverse diode
 $I_F = f(V_{SD})$
parameter: T_J , $t_p = 80 \mu\text{s}$
(spread)



632

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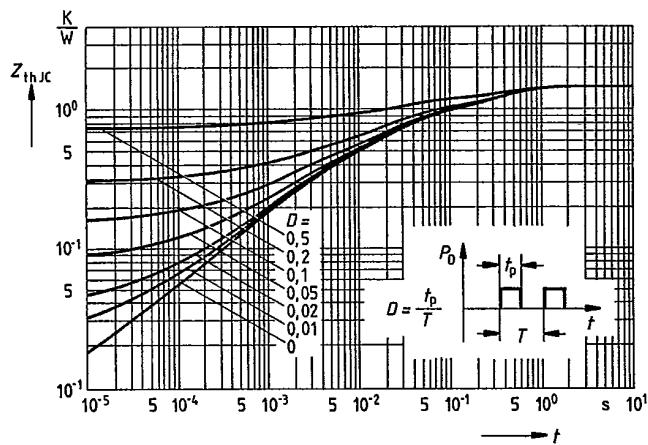
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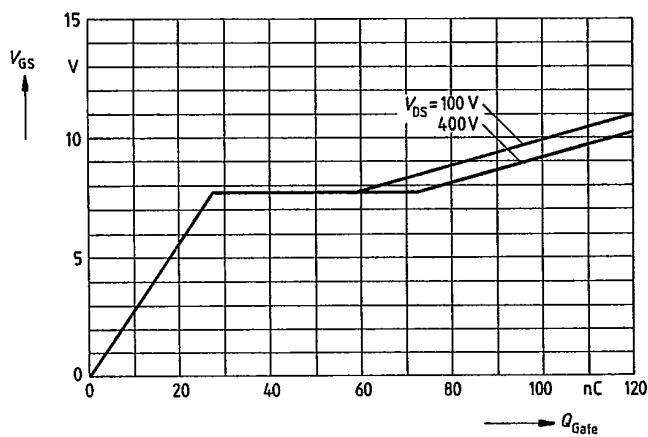
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Transient thermal impedance $Z_{thJC} = f(t)$
parameter: $D = t_p/T$



Typical gate-charge $V_{GS} = f(Q_{Gate})$
parameter: $I_{D\text{ puls}} = 14.4A$



633

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C-06